

Zytel® PC310 NC010

NYLON RESIN

Zytel® PC310 NC010 is a lubricated polyamide 66 resin for injection molding. It has been developed for consideration into applications such as parts for the healthcare industry.

PREMIUM CONTROL for HEALTHCARE APPLICATIONS

This product is manufactured according to Good Manufacturing Practice (GMP) principles and generally accepted in food contact applications in Europe and the USA when meeting applicable use conditions. This product is also tested against selected ISO 10993 parts including 10993-5 and -11 as well as USP class VI and US FDA drug and device master files (DMF and MAF) have been established. For details, individual compliance statements are available from our representative.

Product information

Resin Identification	PA66	ISO 1043
Part Marking Code	>PA66<	ISO 11469
ISO designation	ISO 16396-PA66,,M1G1NR,S14-030	

Rheological properties

	dry/cond.		
Viscosity number	150 ^[1] /*	cm ³ /g	ISO 307, 1628
Moulding shrinkage, parallel	1.4 / -	%	ISO 294-4, 2577
Moulding shrinkage, normal	1.4 / -	%	ISO 294-4, 2577

[1]: Sulfuric acid 96%

Typical mechanical properties

	dry/cond.		
Tensile modulus	3100 / 1400	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	82 / 55	MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	4.5 / 25	%	ISO 527-1/-2
Nominal strain at break	25 / >50	%	ISO 527-1/-2
Tensile strain at break, 50mm/min	4.5 / -	%	ISO 527-1/-2
Flexural modulus	2800 / 1200	MPa	ISO 178
Tensile creep modulus, 1h	* / 1400	MPa	ISO 899-1
Tensile creep modulus, 1000h	* / 820	MPa	ISO 899-1
Charpy impact strength, 23°C	N / N	kJ/m ²	ISO 179/1eU
Charpy impact strength, -30°C	400 / N	kJ/m ²	ISO 179/1eU
Charpy notched impact strength, 23°C	5.5 / 15	kJ/m ²	ISO 179/1eA
Charpy notched impact strength, -30°C	4.5 / 3	kJ/m ²	ISO 179/1eA
Hardness, Rockwell, M-scale	79 / 59		ISO 2039-2
Hardness, Rockwell, R-scale	121 / 108		ISO 2039-2
Poisson's ratio	0.37 / 0.43		

Thermal properties

	dry/cond.		
Melting temperature, 10°C/min	262 / *	°C	ISO 11357-1/-3
Glass transition temperature, 10°C/min	60 / 20	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	70 / *	°C	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	200 / *	°C	ISO 75-1/-2
Vicat softening temperature, 50°C/h 50N	240 / *	°C	ISO 306
Coefficient of linear thermal expansion (CLTE), parallel	100 / *	E-6/K	ISO 11359-1/-2

Zytel® PC310 NC010

NYLON RESIN

Coefficient of linear thermal expansion (CLTE), normal	110/*	E-6/K	ISO 11359-1/-2
Thermal conductivity of melt	0.16	W/(m K)	ISO 22007-2
Effective thermal diffusivity, flow	5E-8	m ² /s	ISO 22007-4
Specific heat capacity of melt	2790	J/(kg K)	ISO 22007-4

Flammability

	dry/cond.		
Burning Behav. at 1.5mm nom. thickn.	V-2/*	class	IEC 60695-11-10
Thickness tested	1.5/*	mm	IEC 60695-11-10
UL recognition	yes/*		UL 94
Burning Behav. at thickness h	V-2/*	class	IEC 60695-11-10
Thickness tested	0.7/*	mm	IEC 60695-11-10
Oxygen index	28/*	%	ISO 4589-1/-2

Electrical properties

	dry/cond.		
Relative permittivity, 100Hz	3.8/6		IEC 62631-2-1
Relative permittivity, 1MHz	3.5/4		IEC 62631-2-1
Dissipation factor, 100Hz	80/2100	E-4	IEC 62631-2-1
Dissipation factor, 1MHz	180/750	E-4	IEC 62631-2-1
Volume resistivity	1E12/1E10	Ohm.m	IEC 62631-3-1
Surface resistivity	*/1E12	Ohm	IEC 62631-3-2
Electric strength	32/28	kV/mm	IEC 60243-1
Comparative tracking index	600/-		IEC 60112

Physical/Other properties

	dry/cond.		
Humidity absorption, 2mm	2.6/*	%	Sim. to ISO 62
Water absorption, 2mm	8.5/*	%	Sim. to ISO 62
Density	1140/-	kg/m ³	ISO 1183
Density of melt	970	kg/m ³	

Film Properties

	dry/cond.		
Strain at yield, parallel	4.5/*	%	ISO 527-3

Injection

Drying Recommended	yes
Drying Temperature	80 °C
Drying Time, Dehumidified Dryer	2 - 4 h
Processing Moisture Content	≤0.2 %
Melt Temperature Optimum	295 °C
Min. melt temperature	280 °C
Max. melt temperature	305 °C
Screw tangential speed	≤0.4 m/s
Mold Temperature Optimum	70 °C
Min. mould temperature	40 °C
Max. mould temperature	95 °C
Hold pressure range	50 - 100 MPa
Hold pressure time	4 s/mm

Zytel® PC310 NC010

NYLON RESIN

Ejection temperature

190 °C

Characteristics

Processing	Injection Moulding
Delivery form	Pellets
Additives	Release agent

Additional information

Injection molding

POSTPROCESSING

Annealing: 30min at 200°C

Chemical Media Resistance

Acids

- ✓ Acetic Acid (5% by mass), 23°C
- ✓ Citric Acid solution (10% by mass), 23°C
- ✓ Lactic Acid (10% by mass), 23°C
- ✗ Hydrochloric Acid (36% by mass), 23°C
- ✗ Nitric Acid (40% by mass), 23°C
- ✗ Sulfuric Acid (38% by mass), 23°C
- ✗ Sulfuric Acid (5% by mass), 23°C
- ✗ Chromic Acid solution (40% by mass), 23°C

Bases

- ✗ Sodium Hydroxide solution (35% by mass), 23°C
- ✓ Sodium Hydroxide solution (1% by mass), 23°C
- ✓ Ammonium Hydroxide solution (10% by mass), 23°C

Alcohols

- ✓ Isopropyl alcohol, 23°C
- ✓ Methanol, 23°C
- ✓ Ethanol, 23°C

Hydrocarbons

- ✓ n-Hexane, 23°C
- ✓ Toluene, 23°C
- ✓ iso-Octane, 23°C

Ketones

- ✓ Acetone, 23°C

Ethers

- ✓ Diethyl ether, 23°C

Salt solutions

- ✓ Sodium Chloride solution (10% by mass), 23°C
- ✗ Sodium Hypochlorite solution (10% by mass), 23°C
- ✓ Sodium Carbonate solution (20% by mass), 23°C

Zytel® PC310 NC010

NYLON RESIN

- ✓ Sodium Carbonate solution (2% by mass), 23°C
- ✗ Zinc Chloride solution (50% by mass), 23°C

Other

- ✓ Ethyl Acetate, 23°C
- ✗ Hydrogen peroxide, 23°C
- ✗ DOT No. 4 Brake fluid, 130°C
- ✗ Ethylene Glycol (50% by mass) in water, 108°C
- ✓ 1% nonylphenoxy-polyethyleneoxy ethanol in water, 23°C
- ✓ 50% Oleic acid + 50% Olive Oil, 23°C
- ✓ Water, 23°C
- ✗ Water, 90°C
- ✗ Phenol solution (5% by mass), 23°C

Sterilisation methods

- ✓ Ethylene Oxide

Symbols used:

- ✓ possibly resistant
Defined as: Supplier has sufficient indication that contact with chemical can be potentially accepted under the intended use conditions and expected service life. Criteria for assessment have to be indicated (e.g. surface aspect, volume change, property change).
- ✗ not recommended - see explanation
Defined as: Not recommended for general use. However, short-term exposure under certain restricted conditions could be acceptable (e.g. fast cleaning with thorough rinsing, spills, wiping, vapor exposure).